

October 2008

KSE13009L High Voltage Switch Mode Applications

- · High Speed Switching
- · Suitable for Switching Regulator and Motor Control



Absolute Maximum Ratings* T_a = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{CBO}	Collector-Base Voltage	700	V
V _{CEO}	Collector-Emitter Voltage	400	V
V _{EBO}	Emitter-Base Voltage	9	V
I _C	Collector Current (DC)	12	Α
I _{CP}	Collector Current (Pulse)	24	Α
I _B	Base Current	6	Α
P _C	Collector Dissipation (T _C =25°C)	130	W
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 65 ~ 150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Electrical Characteristics* Ta=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V _{CEO} (sus)	Collector-Emitter Sustaining Voltage	I _C = 10mA, I _B = 0	400			V
I _{EBO}	Emitter Cut-off Current	$V_{EB} = 7V, I_{C} = 0$			1	mA
h _{FE}	DC Current Gain	$V_{CE} = 5V, I_{C} = 5A$	8		40	
		$V_{CE} = 5V, I_{C} = 8A$	6		30	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C = 5A, I _B = 1A			1	V
		$I_C = 8A, I_B = 1.6A$			1.5	V
		$I_{\rm C}$ = 12A, $I_{\rm B}$ = 3A			3	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C = 5A, I _B = 1A			1.2	V
		$I_C = 8A, I_B = 1.6A$			1.6	V
C _{ob}	Output Capacitance	V _{CB} = 10V , f = 0.1MHz		180		pF
f _T	Current Gain Bandwidth Product	$V_{CE} = 10V, I_{C} = 0.5A$	4			MHz
t _{ON}	Turn On Time	V _{CC} =125V, I _C = 8A			1.1	μS
t _{STG}	Storage Time	$I_{B1} = -I_{B2} = 1.6A$			3	μS
t _F	Fall Time	$R_L = 15,6\Omega$			0.7	μS

^{*} Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

Typical Characteristics

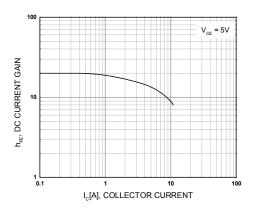


Figure 1. DC current Gain

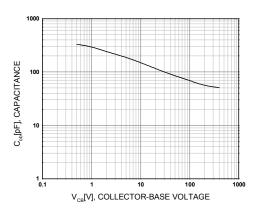


Figure 3. Collector Output Capacitance

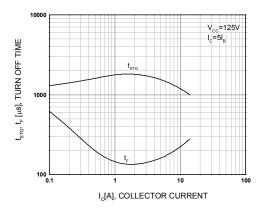


Figure 5. Turn Off Time

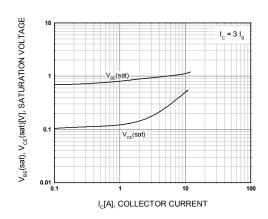


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

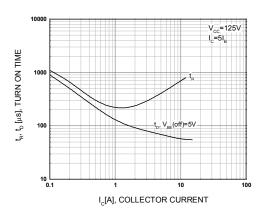
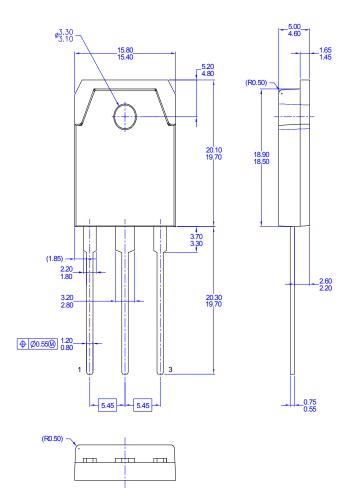


Figure 4. Turn On Time

Package Dimension (TO-3P)



NOTES:
A) THIS PACKAGE CONFORMS TO EIAJ SC-65 PACKAGING STANDARD.
B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONING AND TOLERANCING PER ASME14.5 1973.
D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
E) DRAWING FILE NAME: TO3P03AREV2.





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